

## **MICRO SATA RECEPTACLE**

### 1.0 SCOPE

This Product Specification covers the performance requirements of the Micro Serial ATA / High Speed Serialized device receptacle connector.

### 2.0 PRODUCT DESCRIPTION

## 2.1 PRODUCT NAME AND SERIES NUMBER(S)

Product Name Part Number

MICRO SATA RECEPTACLE, VERTICAL SMT

78492-0001

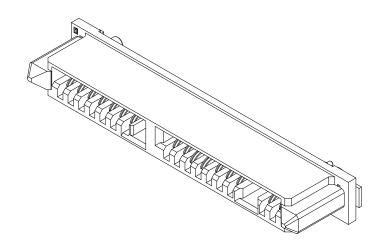
### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See Sales Drawing SD-78492-001 for information on dimensions, materials, platings and markings.

### 2.3 SAFETY AGENCY APPROVALS

UL FILE : E29179

CSA: 1699020 (LR19980)



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### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents form a part of this specification to the extend specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In addition, in event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

**SATA Specification** 

### 4.0 RATINGS

### 4.1 VOLTAGE

30 Volts Max

### **4.2 CURRENT**

1.5 Amps DC or AC (RMS) Max @ 60 Hz

### 4.3 TEMPERATURE

Operating:  $-0^{\circ}\text{C}$  to  $+55^{\circ}\text{C}$ Non Operating:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ 

### 4.4 HUMIDITY

20% - 80%

#### 4.5 ATMOSPHERIC PRESSURE

650mm – 800mm Hg

#### **5.0 PERFORMANCE**

### **5.1 ELECTRICAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Low Level Contact Resistance (LLCR)	Subject mated contacts assembled in housing to <b>20</b> mV maximum open circuit at <b>100</b> mA maximum. (EIA 364-23)	<b>30</b> mΩ  MAXIMUM [Initial] <b>15</b> mΩ  MAXIMUM [Delta change from Initial]
2	Insulation Resistance	Apply a voltage of <b>500</b> VDC for <b>1</b> minute between adjacent terminals. Measure the insulation resistance for mated and unmated connectors (EIA 364-21)	<b>1000</b> ΜΩ ΜΙΝΙΜUΜ

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3	Contact Current Rating (Power Segment)	<ul> <li>Mount connector to a test PCB with ½ oz copper layer.</li> <li>Wire two adjacent pins in parallel for supply (or the minimum number required by the connector type)</li> <li>Wire two adjacent pins in parallel for return (or the minimum number required by the connector type)</li> <li>Apply a DC current of two times the current rating per contact to the supply pins, returning through the return pins.</li> <li>Record temperature rise when thermal equilibrium is reached.</li> </ul>	1.5 A per pin MINIMUM  Temperature rise shall not exceed 30°C at any point in the connector when contacts are powered  Still Air at Ambient temperature 25°C
4	Dielectric Withstanding Voltage	Apply a voltage of <b>500</b> VAC for <b>1</b> minute between adjacent terminals of mated and unmated connectors. (EIA 364-20 Method B)	No breakdown

# **5.2 MECHANICAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
	Connector Insertion	Mate and Unmate connector assemblies	MAXIMUM Insertion Force : 20 N
5	and	at a rate of <b>12.5</b> mm per minute.	&
	Removal Forces	(EIA 364-13)	MINIMUM Removal Force: 2.5 N
			[Initial and after 500 cycles]
6	Durability		No Physical damage
		<b>500</b> cycles for backplane/blindmate application. All at a maximum rate of <b>200</b> cycles per hour. (EIA 364-09)	Meet requirements of additional tests as specified in the test sequence in Section 7.0
7	Component Retention Force	Apply axial pull out force on solder tab in the housing at a rate of <b>25.4</b> mm per minute.	Terminal 3.00 N MINIMUM retention force  Solder Tab 3.50 N
			MINIMUM retention force

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	8	Physical Shock	Subject mated connector to <b>30</b> g's half-sine shock pulses of <b>11</b> msec duration. Three shocks in each direction applied along three mutually perpendicular planes for a total of <b>18</b> shocks.  (EIA 364-27 Condition H)	No Physical damage  No discontinuities of 1 μs or longer duration
9		Random Vibration	Subject mated connector to <b>5.35</b> g's RMS. <b>30</b> minutes in each of the three mutually perpendicular planes. (EIA 364-28 Condition V Test letter A)	No discontinuities of 1 μs or longer duration

### **5.3 ENVIRONMENTAL REQUIREMENTS**

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
10	Humidity	Subject the connector to temperature and humidity of <b>40</b> °C at <b>95</b> % RH for <b>96</b> hours. (EIA 364-31 Method II Test Condition A)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0
11	Resistance to Soldering Heat	Refer to Section 9.0 for soldering profile	No damage in appearance of connector
12	Solderability	Solder Time : $3 \pm 0.5$ seconds Solder Temperature : $260 \pm 5^{\circ}$ C	95% MIN Solder coverage
13	Temperature Life	Subject mated connector to temperature life at <b>+85</b> °C for <b>500</b> hours. (EIA 364-17 Test Condition III Method A)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0
14	Thermal Shock	Subject connector to <b>10</b> cycles between <b>-55°</b> C and <b>+85°</b> C. (EIA 364-32 Test Condition I)	No Physical damage  Meet requirements of additional tests as specified in the test sequence in Section 7.0

## **6.0 PACKAGING**

Refer to Sales Drawing SD-78492-001 for packing details.

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### 7.0 TEST SEQUENCES

Test Group →	Α	В	С	D	E	F	G
Test or Examination <b>Ψ</b>							
Examination of the connector(s)	1, 5	1, 9	1, 8	1, 8	1	1, 5	
Low Level Contact Resistance (LLCR)	2, 4	3, 7	2, 4, 6				
Insulation Resistance				2, 6			
Dielectric Withstanding Voltage				3, 7			
Current Rating			7				
Insertion Force		2				2	
Removal Force		8				4	
Durability	3	4 <sup>(a)</sup>				3 <sup>(b)</sup>	
Physical Shock		6					
Vibration		5					
Humidity				5			
Temperature Life			3				
Reseating (manually unplug/plug three times)			5				
Thermal Shock				4			
Resistance to Soldering Heat					3		
Component Retention Force					2, 4		
Solderability							1

### Note -

- (a) Preconditioning, 20 cycles for the 50-durability cycle requirement, 50 cycles for the 500-durability cycles requirement. The insertion and removal cycle is at the maximum rate of 200 cycles per hour.
- (b) Backplane Receptacle 500cycles, Cable Power or Signal Receptacles 50cycles,
  - Insertion/Removal force of Cable Power Receptacles to be measured for 1<sup>st</sup> to 5<sup>th</sup> cycles as well. The insertion and removal cycle is at the maximum rate of 200 cycles per hour.

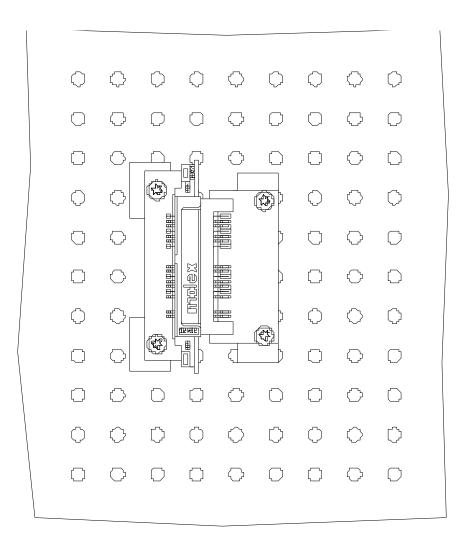
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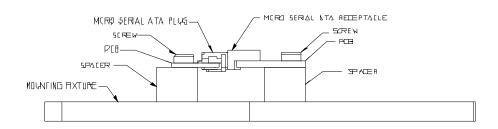
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# 8.0 VIBRATION/SHOCK TEST SET-UP (FOR REFERENCE ONLY)

Micro SATA plug with backplane receptacle



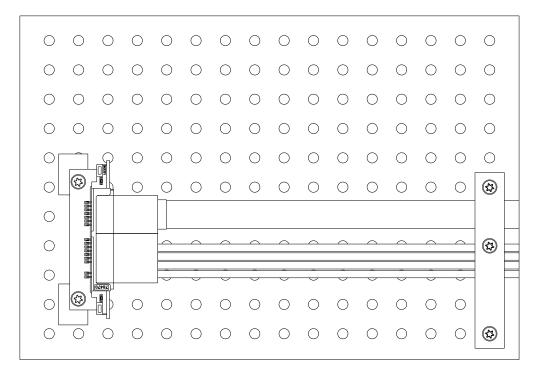


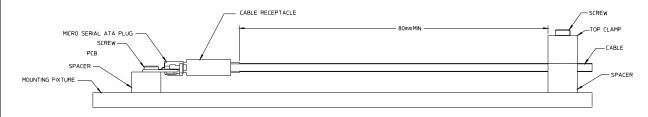
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## 8.0 VIBRATION/SHOCK TEST SET-UP (FOR REFERENCE ONLY)

Micro SATA plug with cable receptacle

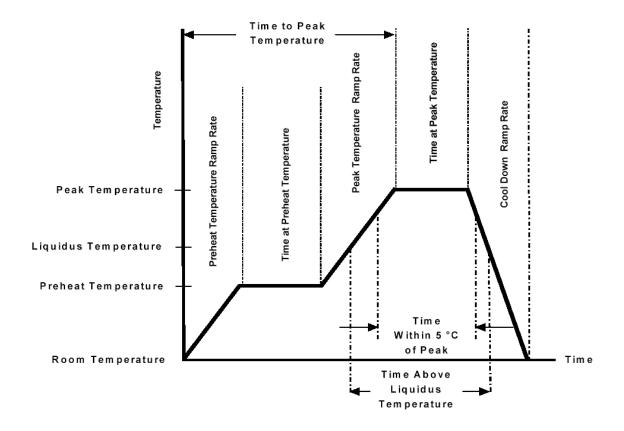




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### 9.0 SOLDERING PROFILE



Description	Requirement		
Average Ramp Rate	3°C/sec Max		
Preheat Temperature	150°C Min to 200°C Max		
Preheat Time	60 to 180 sec		
Ramp to Peak	3°C/sec Max		
Time over Liquidus (217°C)	60 to 150 sec		
Peak Temperature	260 +0/-5°C		
Time within 5°C of Peak	20 to 40 sec		
Ramp - Cool Down	6°C/sec Max		
Time 25°C to Peak	8 min Max		

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